

MOSFET - Power, Single N-Channel, SUPERFET® V, FAST, TO247-3L

600 V, 41 mΩ, 57 A

NTHL041N60S5H

Description

The SUPERFET V MOSFET FAST series helps maximize system efficiency by the extremely low switching losses in hard switching application.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ. $R_{DS(on)} = 32.8 \text{ m}\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Telecom / Server Power Supplies
- EV Charger / UPS / Solar / Industrial Power Supplies

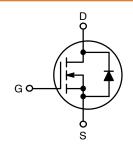
ABSOLUTE MAXIMUM RATINGS (T_J = 25°C, Unless otherwise noted)

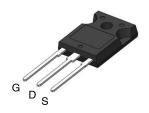
Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V_{DSS}	600	V
Gate-to-Source Voltage	DC	V_{GSS}	±30	V
	AC (f > 1 Hz)		±30	
Continuous Drain Current	T _C = 25°C	I _D	57	Α
	T _C = 100°C		36	
Power Dissipation	T _C = 25°C	P _D	329	W
Pulsed Drain Current (Note 1)	T _C = 25°C	I _{DM}	200	Α
Pulsed Source Current (Body Diode) (Note 1)	T _C = 25°C	I _{SM}	200	Α
Operating Junction and Storage Temperature Range		T_J , T_{STG}	-55 to +150	°C
Source Current (Body Diode)		Is	57	Α
Single Pulse Avalanche Energy	$I_L = 8 A,$ $R_G = 25 \Omega$	E _{AS}	560	mJ
Avalanche Current		I _{AS}	8	Α
Repetitive Avalanche Energy (Note 1)		E _{AR}	3.29	mJ
MOSFET dv/dt		dv/dt	120	V/ns
Peak Diode Recovery dv/dt (Note 2)			20	
Lead Temperature for Soldering Purposes (1/8" from case for 10 seconds)		TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. $I_{SD} \le 28.5 \text{ A}$, di/dt $\le 200 \text{ A/}\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

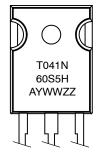
V _{DSS}	R _{DS(ON)} MAX	I _D MAX	
600 V	41 mΩ @ 10 V	57 A	





TO-247 Long Leads CASE 340CX

MARKING DIAGRAM



T041N60S5H = Specific Device Code
A = Assembly Location
YWW = Data Code (Year & Week)

ZZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
NTHL041N60S5H	TO-247	30 Units / Tube

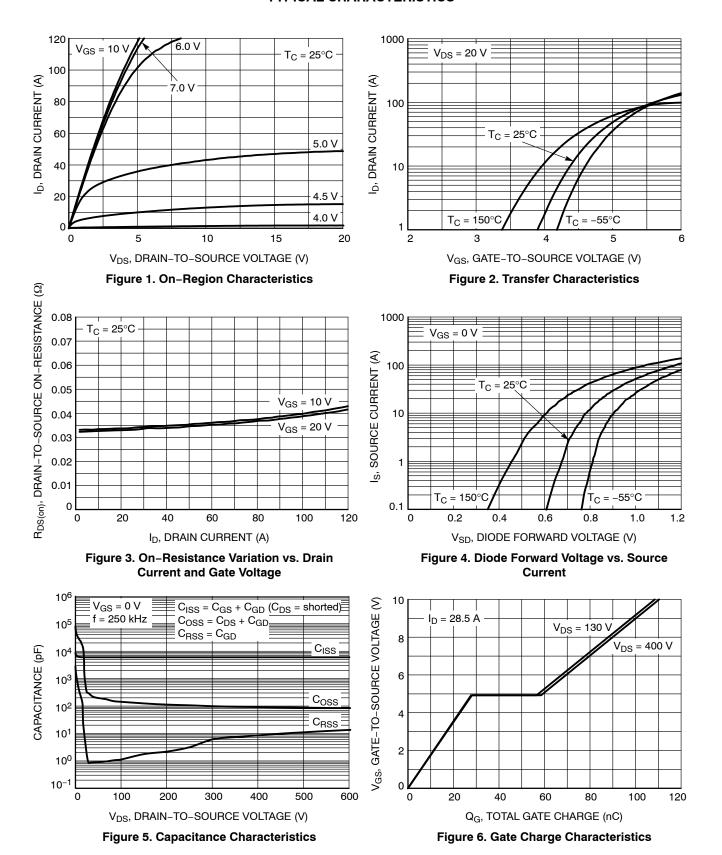
THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max.	$R_{ heta JC}$	0.38	°C/W
Thermal Resistance, Junction-to-Ambient, Max.	$R_{\theta JA}$	40	

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$	600	_	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	ΔV _{(BR)DSS} / ΔΤ _J	I _D = 10 mA, Referenced to 25°C	-	630	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 600 V, T _J = 25°C	-	_	2	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±30 V, V _{DS} = 0 V	_	_	±100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_D = 28.5 A, T_J = 25°C	-	32.8	41	mΩ
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 6.7 \text{ mA}, T_J = 25^{\circ}\text{C}$	2.7	_	4.3	V
Forward Trans-conductance	9FS	V _{DS} = 20 V, I _D = 28.5 A	ı	66	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C _{ISS}	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 250 \text{ kHz}$	-	5840	-	pF
Output Capacitance	C _{OSS}		-	92	-	1
Time Related Output Capacitance	C _{OSS(tr.)}	I_D = Constant, V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	1451	-	
Energy Related Output Capacitance	C _{OSS(er.)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	_	155	-	
Total Gate Charge	Q _{G(tot)}	V _{DD} = 400 V, I _D = 28.5 A, V _{GS} = 10 V	_	108	-	nC
Gate-to-Source Charge	Q_{GS}		-	28	-	1
Gate-to-Drain Charge	Q_{GD}		-	29	-	1
Gate Resistance	R_{G}	f = 1 MHz	ı	0.6	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{GS} = 0/10 \text{ V}, V_{DD} = 400 \text{ V},$	-	33	-	ns
Rise Time	t _r	$I_D = 28.5 \text{ A}, R_G = 2.2 \Omega$	-	11	-	1
Turn-Off Delay Time	t _{d(off)}		-	81	-	1
Fall Time	t _f		ı	2	-	
SOURCE-TO-DRAIN DIODE CHARAC	TERISTICS					
Forward Diode Voltage	V_{SD}	V_{GS} = 0 V, I_{SD} = 28.5 A, T_{J} = 25°C	-	_	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, I_{SD} = 28.5 \text{ A},$	-	461	-	ns
Reverse Recovery Charge	Q _{RR}	dl/dt = 100 A/μs, V _{DD} = 400 V	-	9566	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



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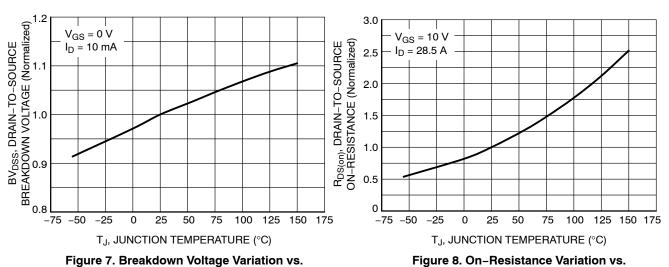


Figure 7. Breakdown Voltage Variation vs. Temperature

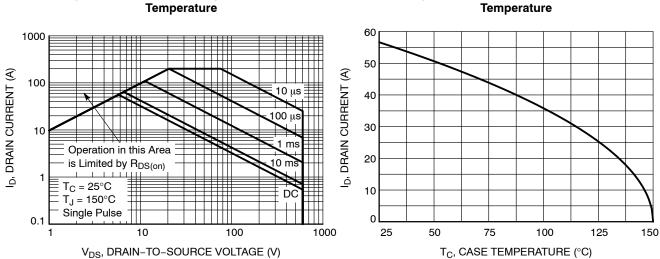


Figure 9. Maximum Safe Operating Area

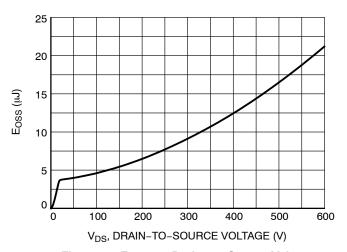


Figure 11. E_{OSS} vs. Drain-to-Source Voltage

Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL CHARACTERISTICS

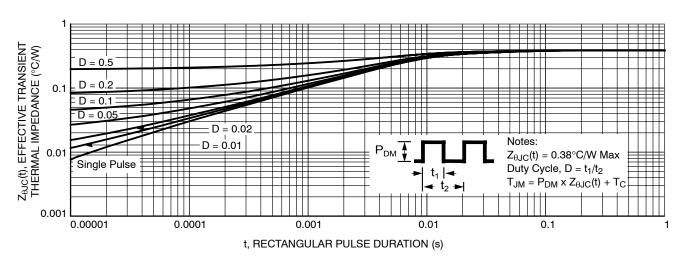


Figure 12. Transient Thermal Impedance

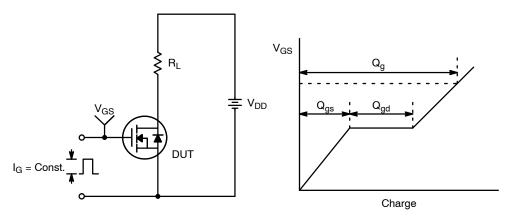


Figure 13. Gate Charge Test Circuit & Waveform

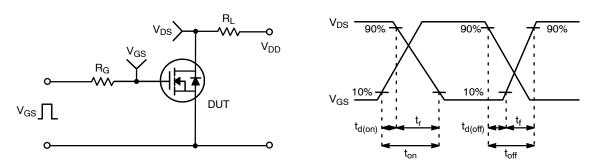


Figure 14. Resistive Switching Test Circuit & Waveforms

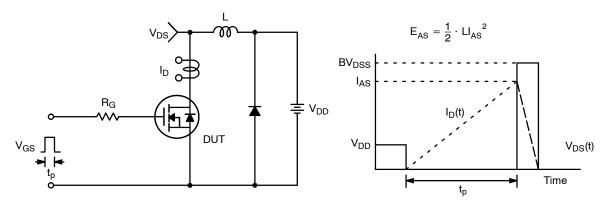


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

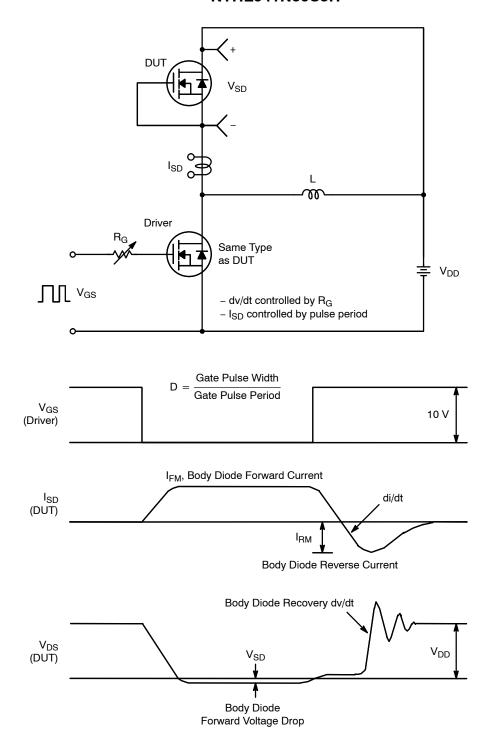
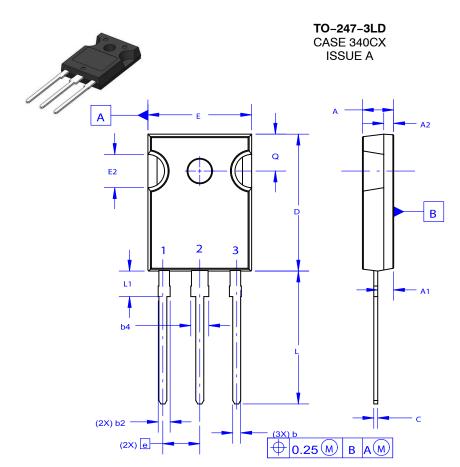
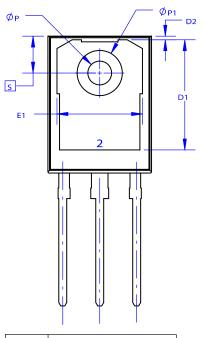


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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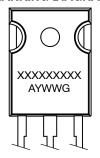


NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location

= Year WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " =", may or may not be present. Some products may not follow the Generic Marking.

DIM	MILLIMETERS		
DIM	MIN	NOM	MAX
Α	4.58	4.70	4.82
A 1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
Е	15.37	15.62	15.87
E2	4.96	5.08	5.20
е	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØΡ	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
С	0.51	0.61	0.71
D1	13.08	~	?
D2	0.51	0.93	1.35
E1	12.81	~	1
ØP1	6.60	6.80	7.00

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